Optical Dependence of Electrically Detected Magnetic Resonance in Lightly Doped Si:P Devices

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Using frequency-modulated electrically detected magnetic resonance (EDMR), we show that signals measured from lightly doped $(1.2-5 \times 10^{15} \text{ cm}^{-3})$ silicon devices vary significantly with the wavelength of the optical excitation used to generate the mobile carriers. We measure EDMR spectra at 4.2 K as a function of modulation frequency and applied microwave power using a 980-nm laser, a 405-nm laser, and a broadband white-light source. EDMR signals are observed from the phosphorus donor and two distinct defect species in all of the experiments. With near-infrared irradiation, we find that the EDMR signal primarily arises from donor-defect pairs, while, at higher photon energies, there are significant additional contributions from defect-defect pairs. The contribution of spins from different spatial regions to the EDMR signal is seen to vary as the optical penetration depth changes from about 120 nm at 405-nm illumination to $100 \ \mu m$ at 980-nm illumination. The modulation frequency dependence of the EDMR signal shows that the energy of the optical excitation strongly modulates the kinetics of the underlying spin-dependent recombination (SDR) process. Careful tuning of the optical photon energy could therefore be used to control both the subset of spin pairs contributing to the EDMR signal and the dynamics of the SDR process.

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I. INTRODUCTION

Spin-based quantum phenomena at the nanoscale hold promise for the development of quantum-enhanced sensing and qubit-based computing architectures. In order to fully realize this potential, however, it is necessary to interface these phenomena to macroscopic scales. Isolated semiconductor dopants and defects offer long coherence times as well as robust and accurate quantum control, and they can be integrated into realistic device geometries. Some of the more intensively studied systems are nitrogen- and silicon-vacancy centers in diamond [1–3], various defects in silicon carbide [4,5], as well as group-V donors in silicon such as phosphorus [6–8], arsenic [9], and bismuth [10].

The most widely studied dopant in silicon is phosphorus (Si:P), which has a single naturally occurring spin-1/2 isotope ³¹P. The coherence times of this system are extremely long, up to seconds for electron spins and tens of minutes for the nuclear spins [11,12], among the longest reported for spins in solids. Furthermore, the use of silicon offers the advantage of mature fabrication methods and ease of integration with commercial nanoelectronics, making it a nearly ideal system in which to engineer scalable quantum technologies [13,14], albeit at cryogenic temperatures (<20 K) to prevent ionization of the donor atoms.

Electrically detected magnetic resonance (EDMR) of Si:P samples was first observed by Schmidt and Solomon over 50 years ago [15] and has become an important tool for magnetic resonance of donors in micro- and nanoscale

silicon devices due to its high sensitivity [16,17]. EDMR in Si:P has been used to electrically detect donor spin states [18], and to read out an ensemble nuclear-spin memory with extremely long lifetimes (>100 s) [19]. Silicon EDMR has been integrated with photoconductive AFM into a scanning probe microscope [20] and has been used to detect the protons from water adsorbed onto the silicon surface [21].

Multiple mechanisms are known to mediate the spindependent transport that enables EDMR in different experimental configurations [22–24]. At low fields (<1 T) where the longest coherence times have been observed, the dominant mechanism is spin-dependent recombination (SDR), where the recombination of a pair of spins depends on their spin permutation symmetry. Resonant excitation of either spin changes this symmetry, modulating the current through the device. In Si:P, such spin pairs can be formed by phosphorus donors and paramagnetic defects located at the Si/SiO₂ interface, between pairs of defects or even between pairs of donors at higher doping concentrations [18,25,26]. At cryogenic temperatures and low-doping concentrations, optical excitation is used to generate the free carriers necessary for EDMR. The influence of this optical excitation on the SDR rates and the observed EDMR signal is still not well understood. While most EDMR experiments have used white-light sources for the optical excitation [17,18,25,27–29], lightemitting diodes [8,26], and laser excitation [16] have also been used. At cryogenic temperatures, the optical penetration depth of light into silicon is known to be strongly wavelength dependent [30]. Thus, both the kinetic energy and the spatial distribution of the photoexcited carriers changes with wavelength. Broadband optical excitation, for example, generates

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both hot carriers and near-band-edge carriers—with differing spatial distributions.

Here, we investigate the wavelength dependence of the EDMR signal at 4.2 K in a lightly doped $(1.2-5 \times 10^{15} \text{ cm}^{-3})$ Si:P device, using three different optical sources: a 980-nm laser whose energy is just above the band edge of silicon at cryogenic temperatures, a 405nm laser to generate hot surface carriers, and a broadband tungsten-halogen lamp white-light source. EDMR signals are observed from the phosphorus donor and two distinct defect species in all of the experiments. With near-infrared irradiation, we find that the EDMR signal primarily arises from donor-defect pairs, while, at higher photon energies, there are significant additional contributions from defectdefect pairs. The contribution of spins from different spatial regions to the EDMR signal is seen to vary as the optical penetration depth changes from about 120 nm at 405-nm illumination to 100 µm at 980-nm illumination. EDMR spectra from spins adjacent to the buried oxide layer in the device are observed to show a significant dispersive component, arising from the passage of microwaves through the conducting-device layer at the surface. Using frequencymodulated (FM) continuous-wave (cw) EDMR, we measure the modulation frequency and microwave power dependence of the EDMR signal for each optical excitation and show that the optical excitation energy strongly modulates the kinetics of the SDR process. Careful tuning of the optical photon energy could therefore be used to control both the subset of spin pairs contributing to the EDMR signal as well as the dynamics of the SDR process.

II. SPIN-DEPENDENT RECOMBINATION

If a sample of Si:P is irradiated with above-gap light at low temperatures, a steady-state photocurrent is generated where the optical excitation rate is balanced by the carrier-recombination rate. If any of the recombination pathways are spin dependent, a resonant excitation of the spins can modulate the recombination rate and transiently change the current through the sample, a mechanism proposed by Kaplan *et al.* [22].

Figure 1(a) illustrates the basic EDMR experiment in Si:P. Shallow phosphorus donor electrons near the Si/SiO₂ interface interact with adjacent (deep) paramagnetic defects present at the interface via either dipolar or exchange interactions. The four energy eigenstates for the spin pair are $|T_{+}\rangle = |\uparrow\uparrow\rangle$, $|T_{-}\rangle = |\downarrow\downarrow\rangle$, and the two admixed states $|1\rangle = a|S_{0}\rangle + b|T_{0}\rangle$ and $|2\rangle = b|S_{0}\rangle - a|T_{0}\rangle$, where $|T_{0}\rangle$ and $|S_{0}\rangle$ are the $m_{s}=0$ triplet and singlet states. For a strongly coupled pair, the states $|1\rangle$ and $|2\rangle$ become the singlet state $|S_{0}\rangle$ and the triplet state $|T_{0}\rangle$ (a=1, b=0), while, for very weak coupling, they become the product states $|\uparrow\downarrow\rangle$ and $|\downarrow\uparrow\rangle$ ($a=b=1/\sqrt{2}$).

Since silicon has low spin-orbit coupling, the recombination process is spin preserving, resulting in faster recombination rates for states with singlet character than

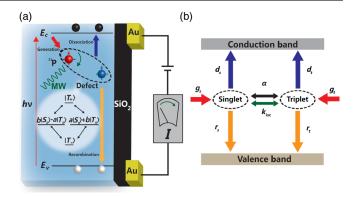


FIG. 1. (a) Schematic of SDR at the Si/SiO₂ interface of a Si:P device. Optically excited electrons in the conduction band can get trapped at phosphorus donor sites that are coupled to adjacent interfacial defect spins. The permutation symmetry of the coupled spin pair determines its recombination rate. Resonantly exciting one of the spins changes the symmetry—and thus the recombination probability—resulting in a change in the electrical current through the device. The eigenstates for the coupled spin pair are also shown. (b) A simple EDMR rate model proposed by Lee $et\ al.\ [31]$. The singlet and triplet pairs are created at rates g_s and $g_t\ (g_t=3g_s)$, dissociate at rates d_s and d_t , and recombine at rates r_s and r_t . Microwave excitation induces a spin-mixing process at rate α , while $k_{\rm isc}$ describes the intersystem crossing between the singlet and triplet manifolds.

for states with triplet character. During steady-state optical excitation, most pairs are pumped into the states $|T_{+}\rangle$ or $|T_{-}\rangle$ since all of the states are generated at the same rate (by nongeminate carriers) but $|1\rangle$ and $|2\rangle$ can recombine relatively quickly, given their singlet content. Resonant microwave excitation of either spin can induce transitions from states $|T_{+}\rangle$ and $|T_{-}\rangle$ to states $|1\rangle$ or $|2\rangle$, resulting in a change in current.

Lee *et al.* proposed a two-component (singlet and triplet) kinetic model to describe the signal dependence observed in cw EDMR experiments that takes into account the competing generation, recombination, and dissociation processes [31]. Figure 1(b) illustrates the key parameters of this model. Under optical excitation, spin pairs are randomly generated in each of the four above configurations with equal probability, so that the singlet and triplet generation rates g_s and g_t are related by $g_t = 3g_s$. The singlet and triplet populations dissociate at rates d_s and d_t , releasing an electron to the conduction band, and recombine at rates r_s and r_t , when one of the electrons in the pair recombines with a hole in the valence band. Transitions between the singlet and triplet manifolds can be induced by either microwave excitation or via relaxation processes. To lowest order, the microwave-induced transition rate α is proportional to the microwave power, while relaxation to thermal-equilibrium populations is assumed to occur at a rate $k_{\rm isc}$ via intersystem crossover. Assuming a simple onoff amplitude modulation scheme, Lee et al. derived a set of coupled differential equations describing the changes to the free-carrier populations and the current through the device. The key equations describing the model are shown in Appendix A.

While the SDR mechanism for phosphorus donors is believed to primarily be mediated by midgap dangling-bond P_{b0} defects [18,25,32,33], previous EDMR measurements have measured E' defects [29] as well as P_{b1} defects and a central donor-pair resonance [25]. It was recently shown that EDMR in Si:P is primarily sensitive to those donors located within roughly the first 20 nm of the Si/SiO₂ surface [34]. The properties of a single donor-defect pair were also recently characterized using scanning probe techniques [35].

III. EXPERIMENTAL SETUP

Figure 2(a) shows a schematic of the experimental setup used. The static magnetic field is generated by a 3-in.diameter electromagnet (Spectromagnetic Model 1019). A microwave synthesizer (QuickSyn FSW-0020) provides a constant carrier frequency of 2.596 GHz, which is mixed (Marki T3-06LQP) with a discrete, numerically generated FM or amplitude-modulation (AM) waveform loaded into a high-frequency arbitrary waveform generator (Tektronix AWG7052). Low-pass filtering (Mini-Circuits VLF-2250+) is used to attenuate the upper sideband and carrier components by approximately 20 dB. The microwaves are then amplified by 30 dB (Mini-Circuits amplifiers ZX60-V62 and ZX60-6019 in series) before being transmitted to the sample. The microwaves are coupled to the sample with a lab-built, low-quality-factor (Q), stripline-fed dielectric antenna mounted on the cold finger of a continuous-flow Janis optical cryostat.

Figure 2(b) shows the mode structure of the half-cylinder dielectric antenna used in the experiment (described in more detail in Appendix B). The relative alignment of the sample and the antenna is set to minimize rf electric-field (\vec{E}) coupling to the electric current (\vec{I}) through the device $(\vec{E} \perp \vec{I})$ since such a coupling can excite microwave-induced currents that could mask the spin-dependent current changes. The strip-line-fed dielectric resonator had a 3-dB bandwidth of 7 MHz, centered at 2.596 GHz, resulting in a O of 371 at T=4.2 K.

A battery and a resistor network are used to provide a constant bias current, I_0 , for a given optical illumination of the Si:P device. The current is fed to an SRS 570 current amplifier, which also compensates for the constant current bias. With 405 nm and white-light excitation, the signals are measured in low-noise mode with a sensitivity setting of 10^{-6} A/V, while the high-bandwidth mode and a 10^{-7} A/V sensitivity are used with the 980-nm excitation. No additional filtering is performed in the current preamplifier. The output of the current amplifier is connected to an SRS 830 lock-in amplifier, to which the FM (or AM) waveform is input as a reference, and whose resulting output is digitized

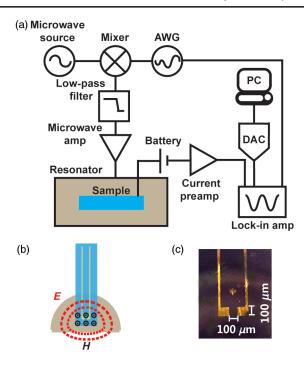


FIG. 2. (a) Block diagram of the key portion of the experimental setup (AWG, arbitrary waveform generator; DAC, digital-to-analog converter; PC, personal computer). (b) Relative position of the sample (shown in blue) and the half cylindrical resonator showing the electric (\vec{E}) and magnetic (\vec{H}) field orientations. (c) Microscope image of the device. The cross in the center is an alignment marker.

using a National Instruments NI-USB-6361 DAQ. The time constant on the SR 830 is set to 100 ms in all of the experiments described here.

The sample used in the experiment is fabricated on a commercial SOI wafer (Ultrasil Corporation). The lightly phosphorus-doped wafer had a device resistivity of 1–4 Ω cm in the $\langle 100 \rangle$ orientation, which corresponds to a phosphorus doping concentration of $1.2–5.0 \times 10^{15}$ cm⁻³. This concentration is significantly lower than the $10^{16}–10^{17}$ cm⁻³ phosphorus donor concentrations used in most previously reported EDMR experiments [36], where exchange interactions between the donors begins to become significant [37]. The sample is mounted with the wafer parallel to the magnetic field.

The (2.0 ± 0.5) - μ m-thick device layer is located on a 1- μ m buried oxide layer. The (500 ± 10) - μ m-thick handle layer is boron doped with a resistivity of 10– $20~\Omega$ cm in the $\langle 100 \rangle$ orientation. The native oxide surface layer has a thickness <10 nm. Gold contacts (100 nm) are thermally evaporated onto the surface, creating a (100×100) - μ m junction as shown in Fig. 2(c). (Additional processing steps are described in Appendix C.) This corresponds to an active device volume (assuming a sensitive depth of 20 nm) on the order of 2.0×10^{-10} cm³ containing about 0.2– 1.0×10^6 donor electron spins. The typical surface density of both P_{b0} and E' defects is in the range of 10^{12} cm⁻² [38–40],

leading to an estimate of about 10^8 defect spins in the active device area.

IV. RESULTS AND DISCUSSION

A. Microwave modulation

Although magnetic-field modulation has traditionally been used for lock-in detection of cw ESR and cw EDMR, the use of small modulation coils (both to minimize inductance and due to space constraints) can lead to larger magnetic-field inhomogeneities [41]. Additionally, vibrations due to Lorentz forces and direct inductive pickup of the field modulation by the electrical leads can lead to increased noise in EDMR signals. AM microwave modulation can also be used to detect EDMR, but the microwave-induced currents in the device electrode also pick up the modulation frequency and can mask the true EDMR signal, as described in the previous section. For FM microwave modulation, the \vec{E} -field coupling to the sample can be minimized since the microwave-induced current is constant over the range of modulation frequencies, so the modulation envelope is transferred into the signal only under magnetic resonance conditions. Here, a triangular envelope is used for the FM frequency variation, with the maximum frequency deviation set to 12 MHz, slightly larger than the measured resonator bandwidth.

Figure 3 shows a comparison between FM EDMR spectra (blue) and AM EDMR spectra (orange) using a 1-kHz modulation frequency under white-light excitation. The central peak is due to surface defects, while the two outer lines correspond to the 4.2-mT (117.54-MHz) hyperfine split lines of the phosphorus donors (g=1.9985) [18,28]. The transconductance gain of the current preamplifier is used to calculate the fractional current change from the measured signal voltage. Note that, although FM EDMR results in derivative line-shape spectra, AM EDMR does not. The peak microwave power delivered to the

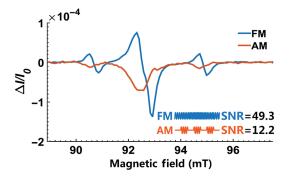


FIG. 3. The cw EDMR spectrum obtained using FM and AM microwave modulation. Each spectrum is acquired at 4.2 K under tungsten-halogen-lamp broadband illumination and 1-kHz modulation frequency. The maximum power of the 2.596-GHz microwave is 3.16 W. The signal-to-noise ratios (SNRs) reported here are for a single scan. A SNR improvement of approximately 4 is obtained for FM over AM. All other experimental parameters are kept the same in the two experiments.

sample is kept constant at 3.16 W in both experiments. Part of the difference in peak signal intensity between the two spectra is likely due to the lower average microwave power (a factor of 3 for a symmetric triangular waveform) in the AM experiment. However, the signal-to-noise ratios (SNRs) measured in the two experiments differ by a factor of 4, indicating a superior sensitivity for FM over AM EDMR. Typical resonant changes in a device current of $\Delta I/I_0 = (10^{-4}-10^{-5})$ are observed.

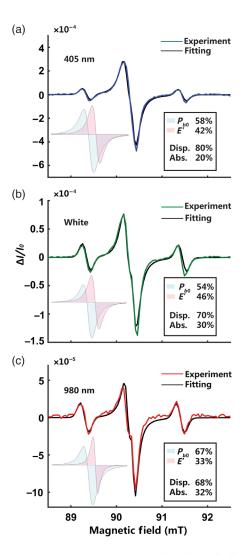


FIG. 4. FM EDMR spectrum measured under optical excitation at (a) 405 nm, (b) white light, and (c) 980 nm. In each panel, the colored line shows the recorded spectrum, while the black line shows a spectral fit. The 117.4-MHz hyperfine-split phosphorus peaks are used to calibrate the field, with the g factor of the phosphorus peak set to g=1.9985. The center defect peak is fit to the sum of two Lorentzian lines, one with a g factor of 2.0058 (assigned to P_{b0}) and the other with a g factor of 2.0002 (assigned to E'). The peak with g factor 2.0058 has a mix of dispersive and absorptive line shapes. These spectra are collected at 4.2 K using a 1-kHz modulation frequency. The microwave power used in these experiments is 3.16 W.

B. Optical selection of spin-pair species

Figures 4(a)–4(c) show the EDMR spectra recorded using a 25-mW, 405-nm laser (3.061 34 eV; Edmond Optics 59562), a 6-W broadband white-light source (OceanOptics LS-1-LL), and a 200-mW, 980-nm laser (1.265 14 eV; ThorLabs L980P200), respectively. Under the same bias conditions, the induced photocurrent (I_0) in the sample is 5 μ A for the blue laser, 40 nA for the infrared laser, and 1 μ A for the tungsten-halogen lamp. For bias voltages under 5 V, the leakage current in the dark is negligible. The microwave power used in these experiments is 3.16 W, which is sufficient to saturate the EDMR spectra, as shown later.

The (peak-to-peak) fractional current change for the phosphorus donors ($\Delta I_{\rm phos}/I_0$) changes from 9.7 \pm 1.8 \times 10^{-5} at 405-nm illumination to about $4.7 \pm 0.3 \times 10^{-5}$ for white light and $3.8 \pm 0.3 \times 10^{-5}$ for 980-nm illumination. The intensity of the central defect peak depends much more strongly on the optical excitation, with $\Delta I_{\text{def}}/I_0$ changing from $7.6 \pm 0.2 \times 10^{-4}$ at 405 nm to $2.20 \pm 0.04 \times 10^{-4}$ under white light and $1.40 \pm 0.02 \times 10^{-4}$ at 980 nm. The ratio between the two signals $\Delta I_{\rm def}/\Delta I_{\rm phos}$ changes from 7.8 ± 1.0 at 405 nm to 4.6 ± 0.1 with white light and 3.6 ± 0.1 at 980 nm. Table I summarizes these results. This change in the ratio between the two signals suggests that additional defect-defect interactions are contributing to the EDMR signal under 405-nm excitation. The area of the defect peak is greater than the sum of the two hyperfinesplit phosphorus peaks in all of the experiments.

At the low donor concentrations used here, we do not expect donor-pair resonances to arise. However, multiple donor-defect and defect-defect EDMR signals are likely to be present. The figures also show the result of a spectral fit. The 117.4-MHz hyperfine-split phosphorus peaks are used to calibrate the field, with the g factor of the phosphorus peak set to g=1.9985. The center defect peak is fit to the sum of two Lorentzian lines. One of the peaks has a g factor of 2.0002, which is close to the reported value (g=2.0005) of deep-hole oxide-trap E' defects [38]. The other peak has a g factor of 2.0058, which is intermediate between the g values reported for P_{b0} [$g_1=2.0015$,

parallel to (111); $g_2 = 2.0080$; $g_3 = 2.0087$, parallel to (011)] and P_{b1} [$g_1 = 2.0012$; $g_2 = 2.0076$, parallel to (111); $g_3 = 2.0052$, parallel to (011)] at the orientation used in the experiment [32,38]. We have labeled this the P_{b0} defect since this is the most commonly observed defect peak in EDMR. The shifts in the observed g factor are most likely due to errors in sample alignment with the field. The peak is also observed to have a mixed absorptive and dispersive character, as can be seen from the fits shown in the bottom left of Figs. 4(a)–4(c). Zevin and Suss showed that such distortions of the line shape can be caused by the microwaves passing through conducting metallic or semiconducting layers [42]. The dispersive component could arise from defect spins in the buried oxide layer. The distortion in the line shape is more obvious under 980-nm excitation, where the optical penetration is the greatest. The contribution of the E' signal also drops, while that of the P_{b0} signal increases for the long-wavelength excitation. This finding suggests that the observed E' defects are primarily located on the top surface, while the P_{b0} defects are present at both the surface and buried oxide layers.

The width of the phosphorus peaks (approximately 3.5 G) and the P_{b0} peak (about 2.7 G) remains relatively unchanged in the different experiments. The width of the E' peak changes from approximately 2.9 G for 405 nm and white-light excitation to about 1.9 G for 980-nm excitation. This finding is consistent with a weaker perturbation of the surface E' spins with long-wavelength excitation.

Given the nominal incident powers and taking literature values for silicon absorption coefficients at these wavelengths [43], the calculated absorbed optical power over the device active volume ranges from 12 μ W at 980 nm to 1.2 mW at 405 nm. However, the induced steady-state photocurrent (I_0) is likely to pass uniformly through the entire 2- μ m device layer for the 980-nm excitation, given the 100- μ m penetration depth, but be more inhomogeneously distributed for the 405-nm excitation. While the optical penetration is restricted to about 120 nm at this wavelength, the carriers are likely to diffuse through the entire 2- μ m device layer. However, the surface contribution to the overall current will be significantly higher for the

TABLE I. Optical dependence in the FM EDMR experiment. P_0 is the nominal optical power of the source; P_I is the optical power incident on the (100×100) - μ m device area (assuming a circular spot size with a 100- μ m radius); $P_{2 \mu m}$ is the optical power deposited in the 2- μ m device layer; I_0 is the steady-state light-induced photocurrent; λ is the characteristic penetration depth for the optical excitation (the inverse of the absorption coefficient); $P_{20 \text{ nm}}$ is the optical power deposited in the top 20 nm, where the SDR process dominates; $\Delta I_{\text{phos}}/I_0$ is the fractional current change of the phosphorus donors; $\Delta I_{\text{def}}/I_0$ is the fractional current change of the defect spins; and $\Delta I_{\text{def}}/\Delta I_{\text{phos}}$ is the ratio of the current change for defects to the current change for the phosphorus.

Source	P_0 (mW)	P_I (mW)	$P_{2\mu\mathrm{m}}$ (mW)	I_0 (μ A)	λ (μm)	P _{20nm} (mW)	$\Delta I_{\rm phos}/I_0~(\times 10^{-5})$	$\Delta I_{\rm def}/I_0~(\times 10^{-5})$	$\Delta I_{ m def}/\Delta I_{ m phos}$
980 nm	200	63.7	1.2	0.04	100	0.012	3.8 ± 0.3	14.0 ± 0.2	3.7 ± 0.1
White	6000	1910		1			4.7 ± 0.3	22.0 ± 0.4	4.7 ± 0.1
405 nm	25	8	8	5	0.12	1.2	9.7 ± 1.8	76.0 ± 2.0	7.8 ± 1.0

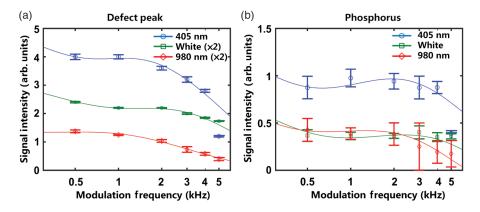


FIG. 5. Modulation frequency dependence of the EDMR signal for the three different optical excitations for (a) the defect signal and (b) the phosphorus donor signal. The microwave power is held constant at 3.16 W in these experiments. The solid lines are simulations of the signal dependence predicted by the two-spin kinetic model shown in Fig. 1(b). The signal intensity is proportional to the area under the resonance peak (see Appendix D).

405-nm excitation than for the 980-nm excitation. This suggests that the fractional current changes can be made much larger using excitation in the infrared if the current paths can be constrained to the surface, as has been done with the use of epitaxially grown silicon layers [34].

The excess energy of the incident photons relative to the silicon band gap is rapidly dissipated through electron and phonon scattering that can significantly modify the kinetics of the SDR process. At 4.2 K, silicon possesses two thresholds for indirect band-gap transitions, with the higher being 1.2135 eV [30]. As a consequence, the types of carriers excited under each illumination vary widely. Excitation at 980 nm, just above the second phonon-mediated absorption threshold, generates relatively low-energy carriers, while 405-nm excitation leads to absorption enhancement of nearly 3 orders in magnitude [44], generating hot carriers and increasing the phonon bath. The broadband white-light source spans both regimes, while also exciting subband transitions such as donor-bound excitonic transitions, as have recently been exploited to perform bias-free EDMR experiments in isotopically enriched silicon-28 samples [6,12].

C. Wavelength-dependent rate changes

In order to better connect to the changing kinetics of the SDR process, we measure the modulation frequency and microwave power dependence of the EDMR signal for each optical excitation. Figures 5(a) and 5(b) show the

modulation frequency dependence of the phosphorous donor and the overall central defect signal intensities. The current change is observed to decrease at higher modulation frequencies in all cases. The change in EDMR with modulation frequency is an indirect probe of the SDR kinetics [26,31]. The solid lines in Fig. 5 show the simulated signal dependence predicted by the kinetic model of the EDMR process described earlier [31]. Note that, while this model was developed for a simple on-off amplitude modulation of the EDMR signal, we use it here to approximately describe the triangular frequency modulation signal measured in our experiments. Table II shows the parameters in these simulations. Dreher et al. have reported singlet and triplet recombination time constants to be 15 μ s and 2 ms, respectively, in Si:P [21]. However, the other rates for this system have not been measured to date. Lee et al. have previously shown that widely differing combinations of electronic rates can give rise to the same observed modulation frequency dependence [31]. In order to constrain the parameters for the model, our initial estimate for these kinetic parameters is taken from Ref. [31], and we assume that these rates would not change by more than an order of magnitude [26], thus keeping the general shape of the modulation dependence the same. Appendix D outlines the detailed data-processing steps and the calculation of the error bars shown.

In general, we see that almost all of the electronic rates for both defects and phosphorus signals are higher for the

TABLE II. Fitting parameters used in Fig. 5 for different optical excitations. $\alpha = 7.2 \times 10^5$ is used in all of the experiments conducted with the same microwave power. We set $g_t = 3g_s$ in all of the experiments and used $g_s = 10^{24}$ for 405-nm excitation, 10^{23} for white-light excitation, and 10^{22} for 980-nm excitation. All parameters are in units of s⁻¹.

		Defects		Phosphorus			
Source	405 nm	White	980 nm	405 nm	White	980 nm	
$\overline{k_{\mathrm{isc}}}$	3.1×10^{4}	2×10^{4}	1×10^{4}	1.4×10^4	9.5×10^{3}	8.7×10^{3}	
r_s	14.9×10^{4}	7.6×10^{4}	6.6×10^{4}	4.6×10^{4}	2.9×10^{4}	2.8×10^{4}	
r_t	8.1×10^{3}	7.8×10^{3}	8.3×10^{3}	5.5×10^{3}	1.9×10^{3}	1.6×10^{3}	
d_s	7.5×10^{3}	5×10^{3}	1×10^{3}	4.9×10^{3}	2.2×10^{3}	1.9×10^{3}	
d_t	4.9×10^{4}	4.5×10^{4}	2×10^4	2.9×10^{4}	2.5×10^{4}	2.4×10^{4}	

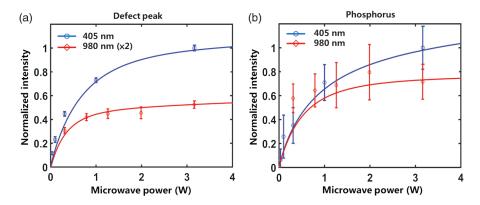


FIG. 6. Microwave power dependence of the EDMR signal for excitation with the 405- and 980-nm laser sources for (a) the defect peak and (b) the phosphorus donor peak. The modulation frequency used is 1 kHz. The solid lines are simulations of the signal dependence predicted by the two-spin kinetic model shown in Fig. 1(b). The signal intensity is proportional to the area under the resonance peak (see Appendix D). The intensities are normalized so that the maximum signal intensity (at 3.16 W) is set to 1.

405-nm-excitation experiment. For the defect signal, the singlet recombination rate at 405 nm is a factor of 2 higher than the rate at 980 nm or with white-light excitation. Overall, the electronic recombination and dissociation rates for the defect signal are observed to be higher than for the phosphorus signal. However, the model fails to capture the signal decrease at the highest modulation frequency under 405 nm excitation. This is probably due to the fact that the observed signal arises from a number of different spin pairs, while the simulations are performed on a single pair. The central defect signal could have contributions from P_{b0} - P_{b0} , P_{b0} -E', E'-E', P_{b0} -phosphorus, and E'phosphorus pairs. Appendix E shows the change in the different defect components as a function of modulation frequency. It should be noted that these signals still represent the average behavior of multiple spin species, and they could be partially correlated with each other.

Figures 6(a) and 6(b) show the microwave power dependence of the two components for the blue and red laser excitation, showing that the fractional current change initially increases with microwave power before saturating, as has been observed previously [16]. To match the curves in Fig. 6, the parameter α is varied (assumed to be directly proportional to power) while all other parameters are kept fixed.

As noted earlier, care should be taken in interpreting the above changes in rate constant quantitatively, as Lee *et al.* have shown that a wide range of combinations of electronic rates can give rise to the same modulation frequency dependence [31].

V. SUMMARY AND OUTLOOK

In this paper, we demonstrate high-sensitivity FM EDMR in lightly doped Si:P devices, making comparative measurements on the optical excitation dependence of the EDMR spectra. We find that photon energies just above silicon's phonon-mediated absorption threshold lead to a spin-spin population dominated by dopant-defect pairs, while the generation of hot carriers greatly increases the population fraction of defect-defect pairs. Two types of defect species are observed, which we ascribe here to P_{b0}

and E' defects. The contribution of an absorptive component to the EDMR signal from the P_{b0} defects suggests that a part of this signal arises from defects adjacent to the buried oxide layer of the silicon-on-insulator sample. The underlying cause of the observed wavelength-dependent changes can be at least partially understood in the context of dramatically different optical absorption cross sections between the two excitation-energy extremes. Optical absorption at the surface $\mathrm{Si/SiO_2}$ interface is enhanced as the photon energy is increased, while the relative contribution of the buried oxide layer is more important at longer wavelengths. Additionally, the SDR-rate kinetics are observed to change with the excitation source, possibly due to the amount of excess energy the photoexcited carrier dissipates during the capture process.

The tuning of surface spin selectivity via optical excitation could enable the use of such silicon-based devices as quantum-enhanced surface-selective biochemical sensors. Demonstrations of this type of technology have been previously accomplished using nitrogen-vacancy (NV) centers in diamond for the local nuclear-magneticresonance (NMR) detection of protons within nm³ voxels [1,3]. However, the difficulty in controlling the orientation of the NV axis in implanted centers makes it challenging to build NV-based sensor arrays with ordered site spacings below the optical diffraction limit. On the other hand, the ability to lithographically pattern structures on silicon surfaces could enable the design of sensor arrays which are highly scalable. As Dreher et al. showed previously, EDMR can be used to detect protons adsorbed onto the silicon surface, analogous to NMR measured by way of NV centers [21]. This coupling between interfacial P_{b0} defects and surface nuclear-spin species has also been observed in dynamic-nuclear-polarization experiments [45,46]. In principle, it should be possible to resonantly detect any spin system—electronic or nuclear—that is coupled to the interfacial defect spins. Paramagnetic electronic states contributing directly to the SDR mechanism would be particularly attractive since their presence or absence could be immediately discerned through acquisition of a simple cw EDMR spectrum. In this case, optimizing optical excitation for surface-localized electronic generation would restrict EDMR readout to interface spin states, enhancing SDR sensitivity to the current fraction arising from this region.

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APPENDIX A: SPIN-PAIR RATE MODEL

A spin pair model described by Lee *et al.* is used to simulate the modulation frequency and power dependence shown in Figs. 5 and 6 [31]. We can use two coupled rate equations to describe the changes to the number of singlet (n_s) and triplet (n_t) spins in the model of Fig. 1(b):

$$\frac{dn_s}{dt} = g_s - (d_s + r_s)n_s + \alpha(n_t - n_s) - k_{isc}(n_s - Fn_s) + k_{isc}[n_t - (1 - F)n_t], \quad (A1)$$

$$\frac{dn_t}{dt} = g_t - (d_t + r_t)n_t + \alpha(n_s - n_t)
- k_{isc}(n_t - Fn_t) + k_{isc}[n_s - (1 - F)n_s], \quad (A2)$$

where g_s , r_s , d_s , g_t , r_t , and d_t are the generation, recombination, and dissociation rates for singlet and triplet spin pairs. α represents the microwave-induced transition rate between n_s and n_t , and $k_{\rm isc}$ describes the intersystem crossing which restores the populations of n_s and n_t to thermal equilibrium. F is the Fermi-Dirac distribution function, $F = (1 + e^{\Delta E/kT})^{-1}$, which is set to 0.25 in the modeling results shown.

These two equations are solved for square-wave AM microwave modulation as shown in Fig. 7, with $\alpha \neq 0$ when the microwaves are on and $\alpha = 0$ when the microwaves are off, resulting in

$$n_s^{\text{on}}(t) = A_{11}e^{-m_{11}t} + A_{21}e^{-m_{21}t} + n_s^{\text{on}}(SS),$$
 (A3)



FIG. 7. The rate model is developed for on-off amplitude modulation of the microwaves. We have assumed that this is equivalent to an on-resonance-off-resonance frequency modulation of the microwaves, which should qualitatively mimic the behavior of the triangular frequency modulation used in our experiments.

$$n_t^{\text{on}}(t) = B_{11}e^{-m_{11}t} + B_{21}e^{-m_{21}t} + n_t^{\text{on}}(SS),$$
 (A4)

$$n_s^{\text{off}}(t) = A_{12}e^{-m_{12}[t-(T/2)]} + A_{22}e^{-m_{22}[t-(T/2)]} + n_s^{\text{off}}(SS),$$
(A5)

$$n_t^{\text{off}}(t) = B_{12}e^{-m_{12}[t-(T/2)]} + B_{22}e^{-m_{22}[t-(T/2)]} + n_t^{\text{off}}(SS),$$
(A6)

where n_s^{on} and n_t^{on} are the singlet and triplet populations when the microwave (MW) pulse is on, and n_s^{off} and n_t^{off} are the singlet and triplet populations when the MW pulse is off. We set t = SS to indicate the steady-state solution obtained when the modulation rate (1/T) is very low. The amplitudes A_{ij} and B_{ij} and the time constants (m_{ij}) of the exponential functions depend on the electronic rates $\alpha, g_s, g_t, r_s, r_t, d_s, d_t$, and k_{isc} . In order to solve for these amplitudes and time-constants, eight boundary conditions are applied to Eqs. (A3)–(A6). The first four conditions represent the periodicity of the solution, namely, $n_s^{\text{on}}(0) = n_s^{\text{off}}(T), n_t^{\text{on}}(0) = n_t^{\text{off}}(T), n_s^{\text{on}}(T/2) = n_s^{\text{off}}(T/2),$ and $n_t^{\text{on}}(T/2) = n_t^{\text{off}}(T/2)$. The other four boundary condition are simply the fact that the only allowed population changes in n_s and n_t are caused by generation, recombination, dissociation, and the two-spin-mixing process.

The electrical signal is proportional to $d_s n_s + d_t n_t$, which leads to the in-phase and out-of-phase electrical signals from the lock-in amplifier [29]:

$$\begin{split} I_{\rm in} &= \frac{2m_{11}}{T} (r_s A_{11} + r_t B_{11}) \left(\frac{1 - e^{-m_{11}T/2} \cos(l\pi)}{m_{11}^2 + 4l^2\pi^2/T^2} \right) \\ &+ \frac{2m_{21}}{T} (r_s A_{21} + r_t B_{21}) \left(\frac{1 - e^{-m_{21}T/2} \cos(l\pi)}{m_{21}^2 + 4l^2\pi^2/T^2} \right) \\ &+ \frac{2m_{12}}{T} (r_s A_{12} + r_t B_{12}) \left(\frac{\cos(l\pi) - e^{-m_{12}T/2}}{m_{12}^2 + 4l^2\pi^2/T^2} \right) \\ &+ \frac{2m_{22}}{T} (r_s A_{22} + r_t B_{22}) \left(\frac{\cos(l\pi) - e^{-m_{22}T/2}}{m_{22}^2 + 4l^2\pi^2/T^2} \right), \end{split} \tag{A7}$$

$$\begin{split} I_{\text{out}} &= \frac{4l\pi}{T^2} (r_s A_{11} + r_t B_{11}) \left(\frac{1 - e^{-m_{11}T/2} \cos(l\pi)}{m_{11}^2 + 4l^2\pi^2/T^2} \right) \\ &+ \frac{4l\pi}{T^2} (r_s A_{21} + r_t B_{21}) \left(\frac{1 - e^{-m_{21}T/2} \cos(l\pi)}{m_{21}^2 + 4l^2\pi^2/T^2} \right) \\ &+ \frac{4l\pi}{T^2} (r_s A_{12} + r_t B_{12}) \left(\frac{\cos(l\pi) - e^{-m_{12}T/2}}{m_{12}^2 + 4l^2\pi^2/T^2} \right) \\ &+ \frac{4l\pi}{T^2} (r_s A_{22} + r_t B_{22}) \left(\frac{\cos(l\pi) - e^{-m_{22}T/2}}{m_{22}^2 + 4l^2\pi^2/T^2} \right) \\ &+ [r_s \Delta n_s(SS) + r_t \Delta n_t(SS)] \left(\frac{\cos(l\pi) - 1}{l\pi} \right), \quad (A8) \end{split}$$

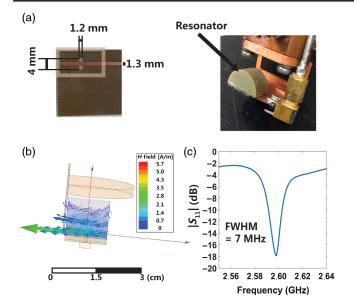


FIG. 8. (a) (Left panel) Micro–strip line and slot used to couple microwaves to the dielectric resonator. (Right panel) Photo of the dielectric resonator. (b) High-frequency electromagnetic-field-simulation software (ANSYS HFSS) simulation for the dielectric resonator at 2.596 GHz. The arrows indicate the magnetic-field vector. The figure on the right shows a schematic of the mode structure. (c) The S_{11} parameter of the resonator measured at 4.2 K with a network analyzer.

where $\Delta n_s(SS) = n_s^{\rm off}(SS) - n_s^{\rm on}(SS)$ and $\Delta n_t(SS) = n_t^{\rm off}(SS) - n_t^{\rm on}(SS)$. In our experiment, we use the magnitude output of the lock-in amplifier instead of measuring the in-phase and out-of-phase signal changes, so the measured signal intensity is proportional to

$$S = \sqrt{I_{\rm in}^2 + I_{\rm out}^2}.$$
 (A9)

APPENDIX B: DIELECTRIC RESONATOR

The half-cylindrical dielectric resonator was purchased from TCI ceramics. The dielectric constant of this resonator is 81.0 ± 2 . The dimensions of this half-cylindrical resonator are shown in Fig. 8(a). Microwaves are coupled to

the dielectric resonator through a strip line fabricated on a two-sided printed circuit board (PCB). A small slot is cut just above the strip line on the opposite side of the PCB and the dielectric resonator is centered over the slot. The $\text{TE}_{01\delta}$ mode is excited at 2.596 GHz at 4.2 K. Figure 8(b) shows an electromagnetic-field simulation (ANSYS HFSS) of the dielectric resonator at 2.596 GHz, and a schematic of the mode structure. Figure 8(c) shows the measured S_{11} parameter of the resonator at 4.2 K, corresponding to a Q factor of 370.9.

APPENDIX C: DEVICE FABRICATION

The wafer is first immersed in a 6:1 buffered-oxide-etch solution for 5 min to remove the native oxide layer on top of the silicon device layer. A 1.5-\mum-thick layer of S1813 Shipley photoresist is then spin coated onto the sample as soon as possible, followed by a 3-min soft bake at 100 °C. The features for the metal contacts are defined by exposure to 26-mW/cm², 405-nm light for 15 s using a mask aligner. The sample is then developed in Microposit MF319 developer for 1 min, which is followed by a 5-min hard bake at 100 °C.

APPENDIX D: DATA ANALYSIS

Figure 9(a) shows the raw EDMR data, illustrating the presence of a linear baseline. In order to correct for this sloped baseline, we fit the baseline of the measured spectra with a first-order polynomial equation and subtract this value from the data, resulting in the flat baselines seen in Figs. 2 and 3. Figure 9(a) also shows the fit used for the baseline correction.

Figure 9(b) shows the slopes of the linear fits obtained as a function of modulation frequency for each of the three optical excitation schemes, showing that the baseline correction does not significantly interfere with our analysis. For the 405-nm laser signal, the slope of the linear fit shows a similar trend when compared to the signal intensity. However, no such dependence is observed for the white-light source and the 980-nm excitation. We currently do not know the origin of the baseline signal. However, one possible explanation is that this slope is related to the

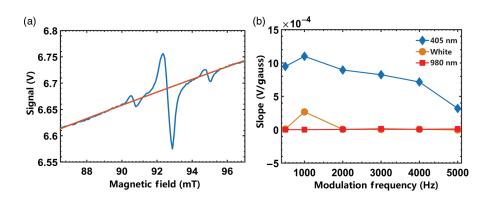


FIG. 9. (a) Raw cw EDMR spectrum (blue line) and first-order polynomial fit used for baseline correction (red line). (b) Slope of the first-order polynomial equation obtained as a function of modulation frequency for each of the three light sources.

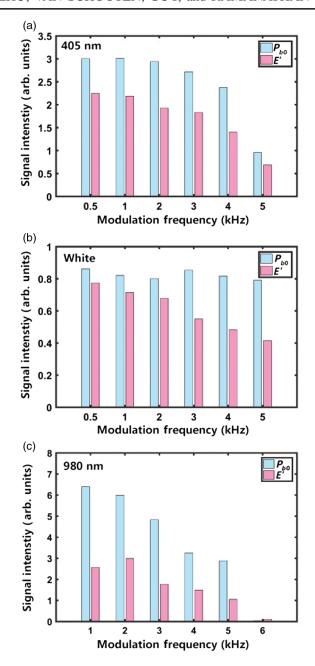


FIG. 10. Change in intensity of the two defect components (as obtained from the spectral fits) as a function of modulation frequency for (a) 405-nm; (b) white light and (c) 980-nm excitation. The signal intensity is proportional to the area under the resonance peak.

magnetoresistance discovered in lightly doped phosphorus silicon [47].

The signal intensity in the main text is calculated from the resonance-peak area after baseline correction. The experimental spectra are scaled by lock-in amplifier and current preamplifier settings. The error bars shown in Figs. 5 and 6 are calculated using the standard deviation of the baseline (following subtraction of the linear fit).

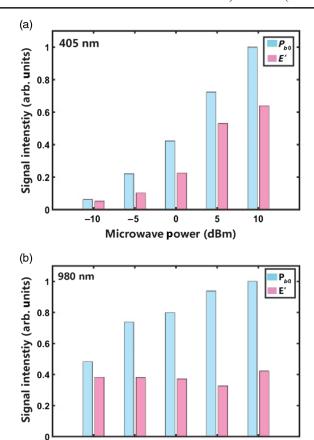


FIG. 11. Change in intensity of the two defect components (as obtained from the spectral fits) as a function of applied microwave power for (a) 405-nm and (b) 980-nm excitation. The signal intensity is proportional to the area under the resonance peak.

6

Microwave power (dBm)

10

0

APPENDIX E: SPECTRAL FITS FOR MODULATION AND POWER DEPENDENCE

We perform two-component fits for the defect spectra measured under different modulation frequency and microwave power excitations. The modulation frequency dependence is shown in Fig. 10, while the microwave power dependence is shown in Fig. 11. The modulation frequency dependence of both components is similar to that of the total signal for the monochromatic excitations at 405 and 980 nm. With white-light excitation, it appears that the main modulation dependence arises from E'defects. The microwave power dependence of the two components follows the overall signal at 405 nm, but at 980 nm it appears that the E' defect signal is independent of microwave power. As noted earlier, care should be taken in interpreting these results, as some of the defect signal also arises from E'- P_{b0} pairs, which results in correlated signals.

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